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- Fast Switching
- Low gate charge (typical 6.2 nC)
- Improved dv / dt capability
- RoHS Compliant



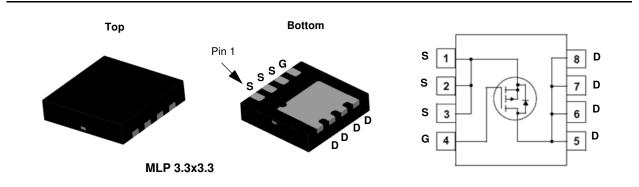
April 2015

General Description

These P-Channel MOSFET enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as audio amplifier, high efficiency switching DC/DC converters, and DC motor control.

Application

Active Clamp Switch



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{DS}	Drain to Source Voltage	-150	V
V _{GS}	Gate to Source Voltage	±30	V
Ι _D	Drain Current -Continuous T _C = 25°C	-3	
	-Continuous $T_{C} = 100^{\circ}C$	-1.8	Α
	-Pulsed	-12	
P _D	Power Dissipation (Steady State) T _C = 25°C	42	W
E _{AS}	Single Pulse Avalanche Energy (Note 5)	3.3	mJ
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C
dv/dt	Peak Diode Recovery dv/dt (Note 2)	-5	V/ns

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	3.0	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	60	C/W

Package Marking and Ordering Information

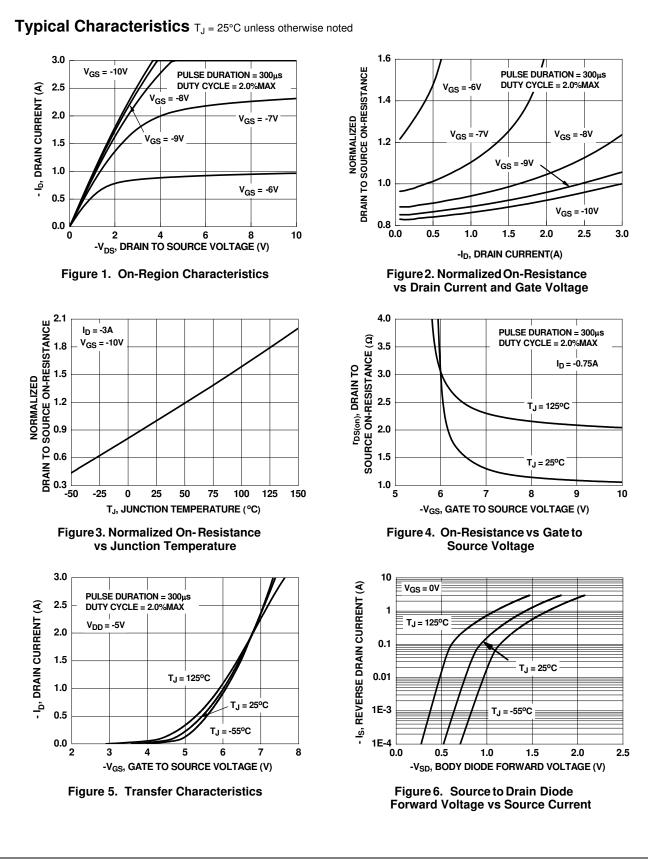
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
2523P	FDMC2523P	MLP 3.3x3.3	13 "	12 mm	3000 units

FDMC2523P P-Channel QFET[®]

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-150			V
ABV _{DSS}	Breakdown Voltage Temperature			100		11/00
ΔT_{J}	Coefficient	$I_D = -250\mu A$, referenced to 25°C		-138		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -150V, V_{GS} = 0V$			-1	μA
		T _J = 125°C			-10	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$			±100	nA
On Chara	octeristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \mu A$	-3	-3.8	-5	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage			6		m)//0C
ΔT_{J}	Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		0		mV/°C
rook	Static Drain to Source On Resistance	V _{GS} = -10V, I _D = -1.5A		1.1	1.5	Ω
r _{DS(on)}	V _{GS} = -10V, I _D = -1.5A , T _J = 125			2.0	3.6	
9 _{FS}	Forward Transconductance	$V_{DS} = -40V, I_D = -1.5A$ (Note 4)		1.4		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance			200	270	pF
C _{oss}	Output Capacitance	$V_{DS} = -25V, V_{GS} = 0V,$		60	80	pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		10	15	pF
R _g	Gate Resistance	f = 1MHz	0.1	7.5	15	Ω
*	- Charactariatica					
	g Characteristics			45	07	1
t _{d(on)}	Turn-On Delay Time	V _{DD} = -75V, I _D = -3A		15	27	ns
t _r	Rise Time Turn-Off Delay Time	$-V_{GS} = -10V, R_{GEN} = 25\Omega$		11 19	20 35	ns
t _{d(off)} t	Fall Time	(Note 3,4)		13	24	ns ns
t _f Q _g	Total Gate Charge	V _{GS} = -10V		6.2	9	nC
	Gate to Source Gate Charge	$V_{DD} = -75V$		1.4		nC
Qas	Gate to Drain "Miller" Charge	I _D = -3A		3.3		nC
Q _{gs}		(Note 3,4)		5.5		no
Q _{gs} Q _{gd}	date to Brain Nimer Charge	(,)				
Q _{gd}	urce Diode Characteristics	(
Q _{gd} Drain-Sou					-3	A
Q _{gd} Drain-Sou	urce Diode Characteristics	le Forward Current			-3 -12	A
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Q _{gd} Drain-Sou	urce Diode Characteristics Maximum continuous Drain - Source Dioc Maximum Pulse Drain - Source Doide For	le Forward Current		-1.8 93	-12	Α
Q _{gd} Drain-Sou Is I _{SM} V _{SD}	urce Diode Characteristics Maximum continuous Drain - Source Dioc Maximum Pulse Drain - Source Doide For Source to Drain Diode Forward Voltage	le Forward Current ward Current $V_{GS} = 0V, I_S = -3.0A$			-12	A V

 $\begin{array}{l} \textbf{2:} \quad I_{SD} \leq \textbf{-3A}, \ dl/dt \leq 300 \text{A/us}, \ V_{DD} \leq B_{VDSS}, \ Starting \ T_J = 25^\circ\text{C} \\ \textbf{3:} \quad \text{Pulse Test: Pulse Width} < 300 \mu\text{s}, \ \text{Duty cycle} < 2.0\%. \\ \textbf{4:} \quad \text{Essentially independent of operating temperature.} \\ \textbf{5:} \quad \text{E}_{AS} \ \text{of } 3.3 \ \text{mJ is based on starting } T_J = 25 \ ^\circ\text{C}; \ \text{P-ch: L} = 3 \ \text{mH}, \ \text{I}_{AS} = \textbf{-1.5 A}, \ \text{V}_{DD} = \textbf{-150 V}, \ \text{V}_{GS} = \textbf{-10 V}. \end{array}$

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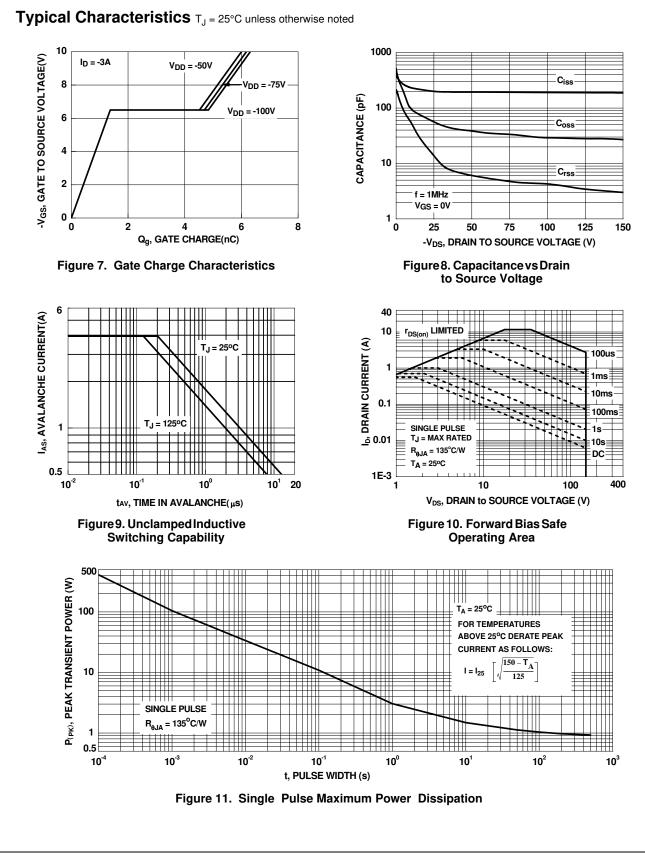


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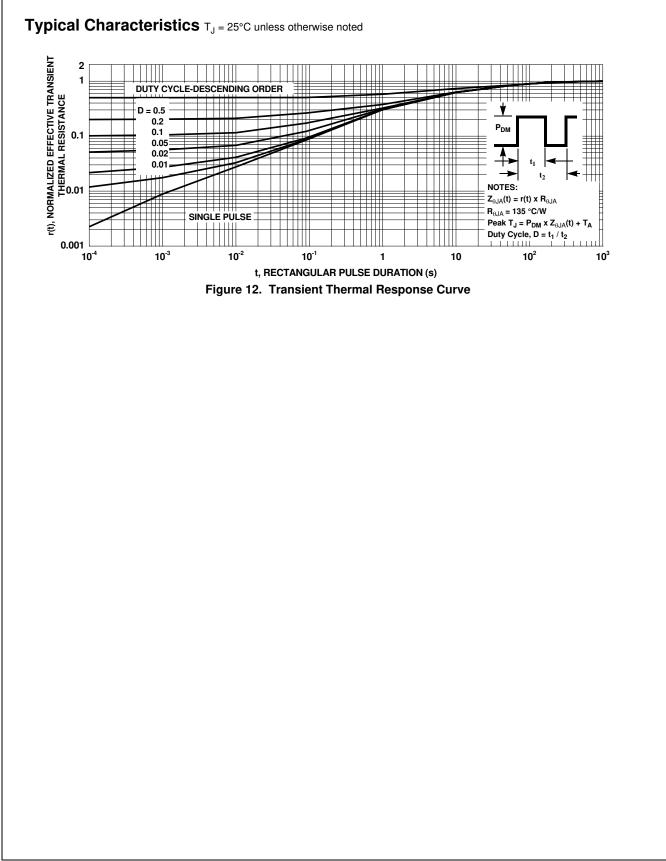
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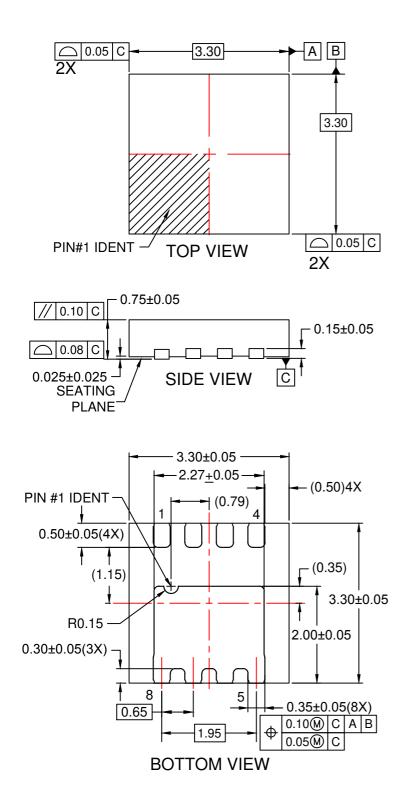


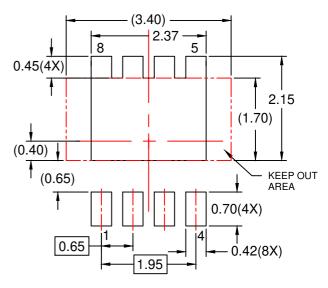


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RECOMMENDED LAND PATTERN

NOTES:

- A. DOES NOT CONFORM TO JEDEC REGISTRATION MO-229
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP08Srev3.



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